

AMENDMENT TRANSMITTAL LETTER			Docket No. M0659.0002
Application No. 10/789,423-Conf. #5684	Filing Date February 27, 2004	Examiner B. P. Sandvik	Art Unit 2826

Applicant(s): Harald Bottner et al.

Invention: SOLDER, MICROELECTROMECHANICAL COMPONENT AND DEVICE, AND A PROCESS FOR PRODUCING A COMPONENT OR DEVICE

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.
The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	22	- 22 =		x	
Independent Claims	7	- 7 =		x	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify): Extension for response within third month					1,020.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					1,020.00

☒ Large Entity
 ☐ Small Entity

☐ No additional fee is required for this amendment.

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Laura C. Brutman

Laura C. Brutman

Attorney/Agent Reg. No.: 38,395

DICKSTEIN SHAPIRO LLP
 1177 Avenue of the Americas
 New York, New York 10036-2714
 (212) 277-6592

Dated: September 19, 2007

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: 9/19/2007 Signature: *Laura C. Brutman* (Laura C. Brutman)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Harald Bottner et al.

Application No.: 10/789,423

Confirmation No.: 5684

Filed: February 27, 2004

Art Unit: 2826

For: SOLDER, MICROELECTROMECHANICAL
COMPONENT AND DEVICE, AND A
PROCESS FOR PRODUCING A
COMPONENT OR DEVICE

Examiner: B. P. Sandvik

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated March 26, 2007, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.